



Product Change Notification

112046 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 112046 - 00
Change Title: Intel® QS57, QS67 & QS77 Express Chipsets,
PCN 112046-00, Transport Media,
Tape and reel seal line distance change
Date of Publication: February 1, 2013

Key Characteristics of the Change:

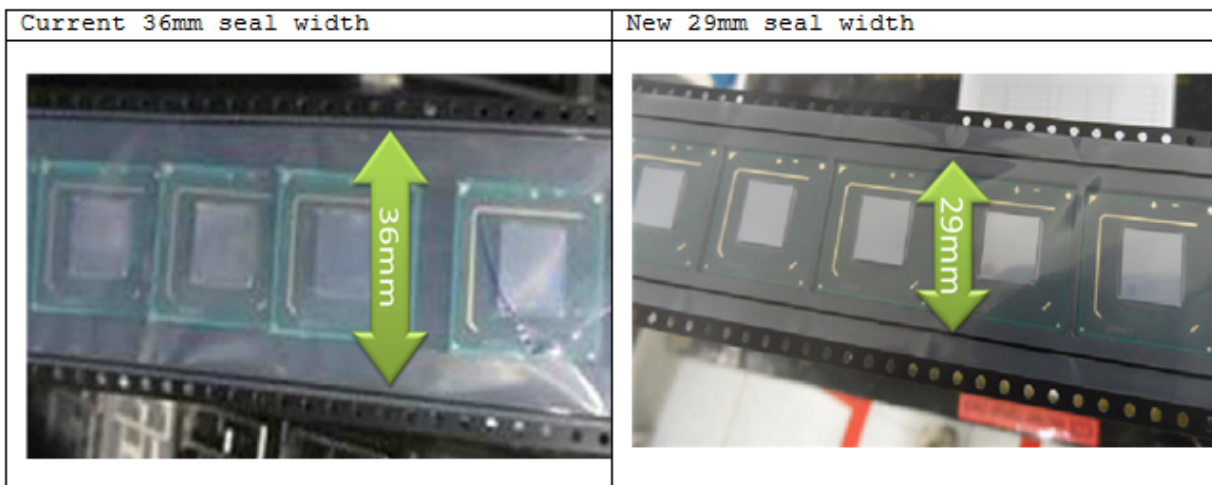
Transport Media

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Mar 04, 2013
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Description of Change to the Customer:

Customers will see a noticeable seal line distance change on select Intel® QS57, QS67 & QS77 Express Chipsets. The current tape and reel seal line of 36mm will be decreasing to 29mm. See photos below:



Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers; however customers may want to notify their manufacturing floor of the change. Customers may see a mix of products until inventory has been depleted.

Products Affected / Intel Ordering Codes:

Marketing Name	Stepping	Product Code	S-Spec	MM#
Intel® BD82QS57 Platform Controller Hub	B3	BD82QS57	S LGZV	904134
Intel® BD82QS67 Platform Controller Hub	B2	BD82QS67	S LHAG	909785
Intel® BD82QS67 Platform Controller Hub	B3	BD82QS67	S LJ4K	914323
Intel® BD82QS77 Platform Controller Hub	C1	BD82QS77	S LJ8B	915660

PCN Revision History:

Date of Revision:

February 01, 2013

Revision Number:

00

Reason:

Originally Published PCN